Small Signal MOSFET

30 V/-20 V, +0.25/-0.88 A, Complementary, SC-88

Features

- Leading 20 V Trench for Low R_{DS(on)} Performance
- ESD Protected Gate
- SC-88 Package for Small Footprint (2 x 2 mm)
- NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DC–DC Conversion
- Load/Power Management
- Load Switch
- Cell Phones, MP3s, Digital Cameras, PDAs

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Par	Symbol	Value	Unit		
Drain-to-Source Volt	N–Ch	V _{DSS}	30	V	
	P-Ch		-20		
Gate-to-Source Volta	N–Ch	V _{GS}	±20	V	
		P-Ch		±12	
N–Channel Continuous Drain	Steady	$T_A = 25^{\circ}C$	Ι _D	0.25	А
Current (Note 1)	State	T _A = 85°C		0.18	
P-Channel Continuous Drain	Steady State	T _A = 25°C		-0.88	
Current (Note 1)		T _A = 85°C		-0.63	
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	0.27	W
Pulsed Drain Cur-	N–Ch	to 10.00	I _{DM}	0.5	А
rent	P-Ch	tp = 10 μs		-3.0	
Operating Junction a	T _J , T _{stg}	–55 to 150	°C		
Source Current (Body	N–Ch	۱ _S	0.25	А	
	P-Ch		-0.48		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	R_{\thetaJA}	460	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on FR4 board using 1 in sq pad size

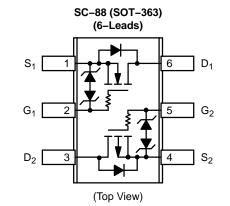
(Cu area = 1.127 in sq [1 oz] including traces).

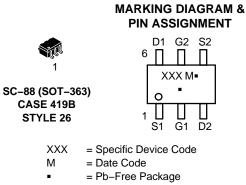


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
N–Ch	1.0 Ω @ 4.5 V	0.25 A
30 V	1.5 Ω @ 2.5 V	0.23 A
P–Ch	215 mΩ @ –4.5 V	-0.88 A
–20 V	345 mΩ @ –2.5 V	-0.00 A





(Note: Microdot may be in either location)

ORDERING INFORMATION

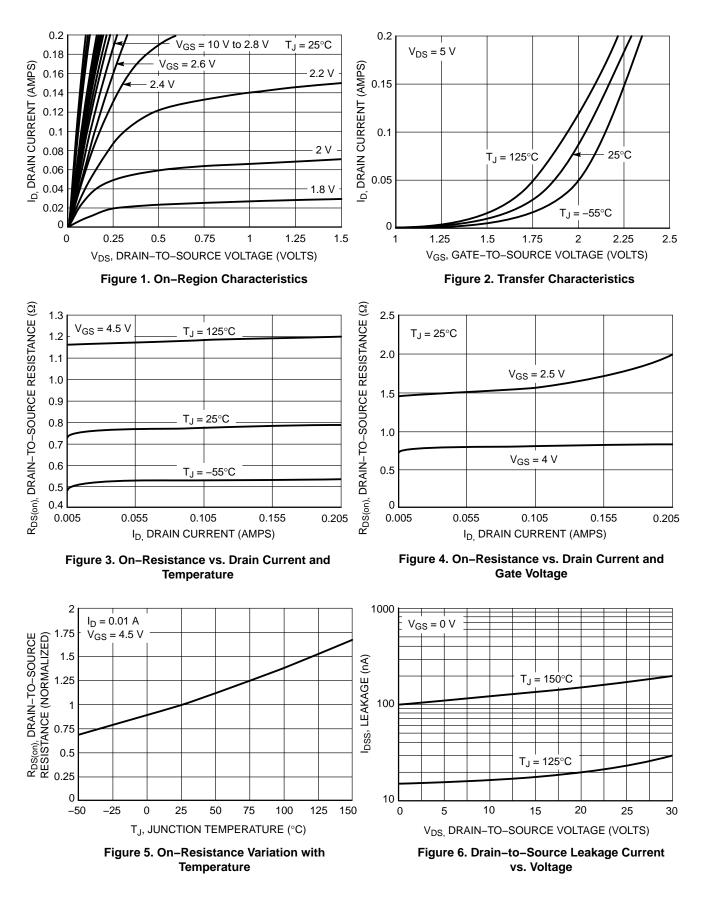
See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	N/P	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS (Note 3)								
Drain-to-Source	V _{(BR)DSS}	Ν	N 0.V	I _D = 250 μA	30			V
Breakdown Voltage	()	Р	V _{GS} = 0 V	$I_{\rm D} = -250 \mu{\rm A}$	-20			1
Drain-to-Source Breakdown	V _{(BR)DSS} /	Ν		5 1		33		mV/
Voltage Temperature Coefficient	TJ	Р				-9.0		°C
Zero Gate Voltage Drain Current	I _{DSS}	Ν	V _{GS} = 0 V, V _{DS} = 30 V	T 0500			1.0	μΑ
C C	200	Р	$V_{GS} = 0 V, V_{DS} = -16 V$	$T_J = 25^{\circ}C$			1.0	1
		Ν	$V_{GS} = 0 V, V_{DS} = 30 V$	-		0.5		1
		Р	$V_{GS} = 0 V, V_{DS} = -16 V$	T _J = 125°C		0.5		1
Gate-to-Source Leakage Current	I _{GSS}	Ν	$V_{DS} = 0 V, V_{GS} = 1$	0 V			1.0	μA
	000	Р	$V_{DS} = 0 V, V_{GS} = -4$				1.0	
ON CHARACTERISTICS (Note 2)	l			-		I		
Gate Threshold Voltage	V _{GS(TH)}	Ν		I _D = 100 μA	0.8	1.2	1.5	V
Cale Inconora Tonago	· 63(1H)	P	$V_{GS} = V_{DS}$	$I_{\rm D} = -250 \mu{\rm A}$	-0.45	=		
Negative Gate Threshold	V _{GS(TH)} /	N		.D _00 p	01.10	3.2		mV/
Temperature Coefficient	TJ	P				-2.7	<u> </u>	°C
Drain-to-Source On Resistance	R _{DS(on)}	N	V _{GS} = 4.5 V, I _D = 10) mA		1.0	1.5	Ω
	09(on)	P	$V_{GS} = -4.5 \text{ V}, \text{ ID} = -600000000000000000000000000000000000$		<u> </u>	0.215	0.260	
		N	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 100000000000000000000000000000000000$			1.5	2.5	4
		P	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ V}$			0.345	0.500	
Forward Transconductance	0ro	N				0.040	0.000	S
	9fs	P	$V_{DS} = 3.0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}$ $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -0.88 \text{ A}$			3.0		
CHARGES, CAPACITANCES AND				.00 A		3.0		
			E		1	20	22	~ [
Input Capacitance	C _{ISS}	N		$V_{DS} = 5.0 V$		20	33	pF
		Р		$V_{DS} = -20 V$		155	225	
Output Capacitance	C _{OSS}	N	f = 1 MHz, V _{GS} = 0 V	V _{DS} = 5.0 V		19	32	
		Р		$V_{DS} = -20 V$		25	40	
Reverse Transfer Capacitance	C _{RSS}	N		V _{DS} = 5.0 V		7.25	12	
	<u> </u>	Р		$V_{DS} = -20 V$		18	30	
Total Gate Charge	Q _{G(TOT)}	N	$V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V},$			0.9	1.5	nC
T	_	Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$			2.2	3.5	
Threshold Gate Charge	Q _{G(TH)}	N	$V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V},$			0.2		
	-	Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$			0.2		
Gate-to-Source Charge	Q_{GS}	Ν	$V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V},$			0.3		
	-	Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$			0.5		
Gate-to-Drain Charge	Q_{GD}	Ν	$V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V},$			0.2		
		Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$	I _D = -0.88 A		0.65		
SWITCHING CHARACTERISTICS (Note 3)							
Turn–On Delay Time	t _{d(ON)}	Ν				15		ns
Rise Time	t _r		V_{GS} = 4.5 V, V_{DD} = 5.0 V, I _D = 250 mA, R _G = 50 Ω			66		
Turn-Off Delay Time	t _{d(OFF)}					56		
Fall Time	t _f					78		
Turn–On Delay Time	t _{d(ON)}	Р	$V_{GS} = -4.5 \text{ V}, V_{DD} = -10 \text{ V},$ $I_D = -0.5 \text{ A}, R_G = 20 \Omega$		5.8			
Rise Time	t _r					6.5]
Turn–Off Delay Time	t _{d(OFF)}					13.5]
Fall Time	t _f					3.5		
DRAIN-SOURCE DIODE CHARAC	FERISTICS							
Forward Diode Voltage	V _{SD}	Ν		I _S = 10 mA	1	0.65	0.7	V
~	00	P	$V_{GS} = 0 V, T_J = 25^{\circ}C$	$I_{\rm S} = -0.48$ A	1	-0.8	-1.2	1
		N	· · · · · · ·	$I_{\rm S} = 10 \rm{mA}$	1	0.45		1
		P	$V_{GS} = 0 V, T_{J} = 125^{\circ}C$	$I_{\rm S} = -0.48$ A	1	-0.66	1	1
Reverse Recovery Time	t _{RR}	N	V _{GS} = 0 V, d _{IS} /d _t = 8.0 A/μs	$I_{\rm S} = 10 \rm{mA}$	<u> </u>	12.4	<u> </u>	ns
Reverse Recovery Time	L L L L L L L L L L L L L L L L L L L							

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

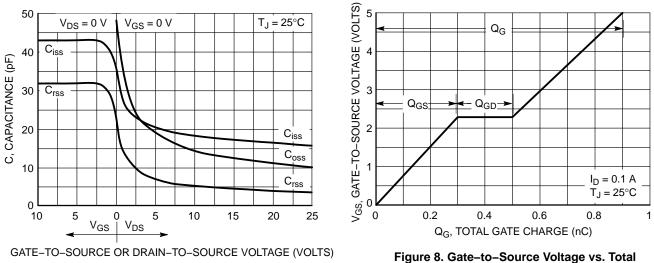


Figure 7. Capacitance Variation



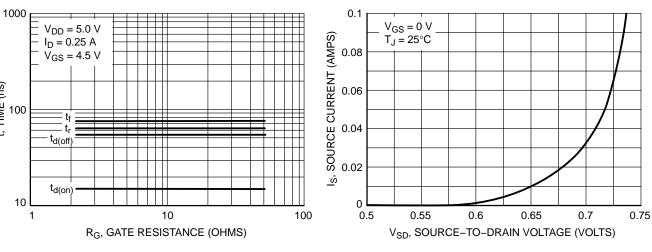
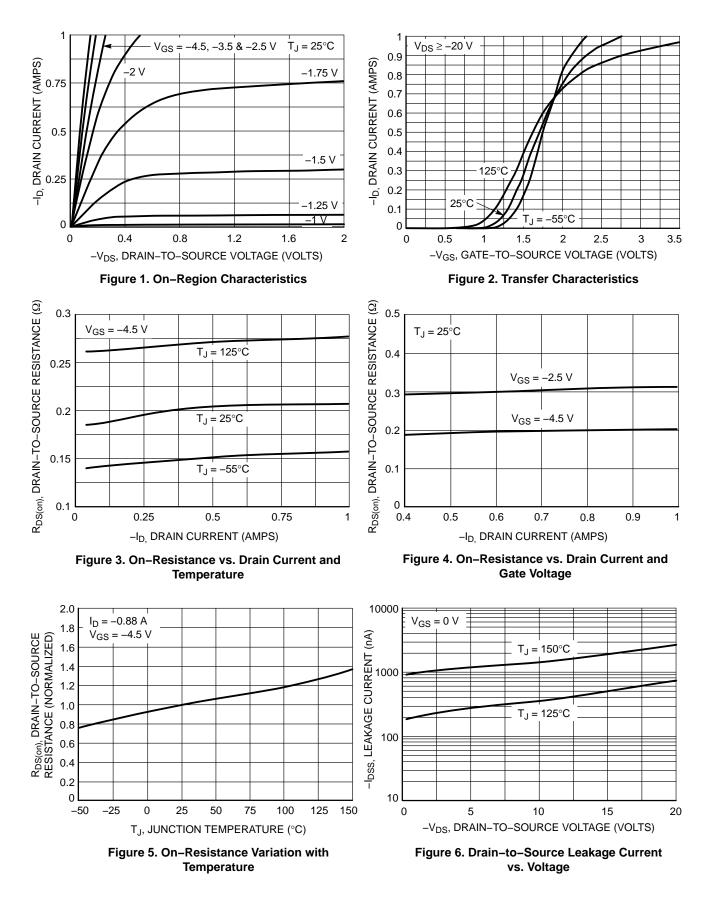


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

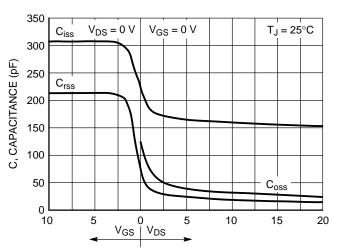
t, TIME (ns)

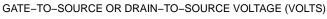
Figure 10. Diode Forward Voltage vs. Current

TYPICAL P-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



TYPICAL P-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)







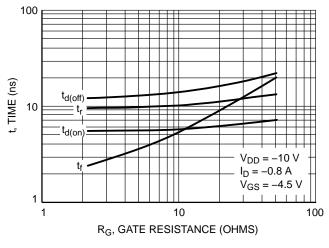


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

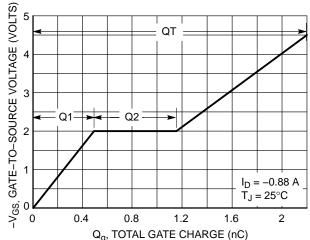


Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

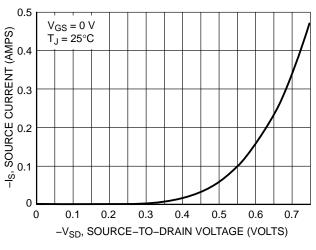


Figure 10. Diode Forward Voltage vs. Current

ORDERING INFORMATION

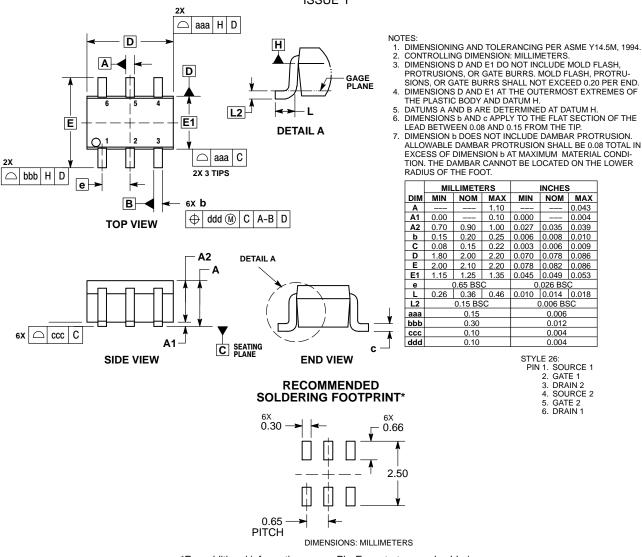
Device	Marking	Package	Shipping [†]		
NTJD4158CT1G	TCD				
NTJD4158CT2G	TCD	SC–88 (Pb–Free)	3000 / Tape & Reel		
NVJD4158CT1G*	VCD	(*******)			

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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3 DRAIN 2 4. SOURCE 2

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